



Power MOSFETS

DATASHEET

LM40072NAP3A

N-Channel
Enhancement Mode MOSFET

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Quality Management Systems

ISO 9001:2015 Certificate

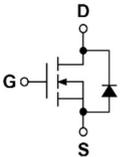
LM40072NAP3A



N-Channel Enhancement Mode MOSFET

Pin Description

Product Summary

TO-220-3L 	Symbol 	Symbol	N-Channel	Unit
		V _{DSS}	40	V
		R _{DS(ON)-Max}	7.2	mΩ
		I _D	91	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Applications

- Switching Mode Power Supply
- Power tools

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM40072NAP3A	TO-220-3L	Tube	50/ Tube	40072 □□□□□□

Note : □□□□□□ = Lot Code

Absolute Maximum Ratings (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit	
V _{DSS}	Drain-Source Voltage	40	V	
V _{GSS}	Gate-Source Voltage	±20		
T _J	Maximum Junction Temperature	150	°C	
T _{STG}	Storage Temperature Range	-55 to 150	°C	
I _S	Diode Continuous Forward Current	T _C =25°C	54	A
I _{DM} ^①	Pulse Drain Current Tested	T _C =25°C	227	A
I _D	Continuous Drain Current	T _C =25°C	91	A
		T _C =100°C	58	
P _D	Maximum Power Dissipation	T _C =25°C	60	W
		T _C =100°C	23.8	
I _D	Continuous Drain Current	T _A =25°C	16.7	A
		T _A =70°C	13.3	
P _D	Maximum Power Dissipation	T _A =25°C	2	W
		T _A =70°C	1.3	
I _{AS} ^②	Avalanche Current, Single pulse	L=0.1mH	32	A
		L=0.5mH	19	
E _{AS} ^②	Avalanche Energy, Single pulse	L=0.1mH	51	mJ
		L=0.5mH	90	

Thermal Characteristics

Symbol	Parameter	Rating	Unit	
R _{θJC}	Thermal Resistance-Junction to Case	Steady State	2.1	°C/W
R _{θJA} ^③	Thermal Resistance-Junction to Ambient	Steady State	62.5	°C/W

Note ① : Max. current is limited by junction temperature

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

N-Channel Electrical Characteristics (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250uA	40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V _{DS} =32V, V _{GS} =0V	-	-	1	uA
V_{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250uA	1.2	1.7	2.4	V
I_{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
R_{DS(ON)} ^④	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =25A	-	6	7.2	mΩ
		V _{GS} =4.5V, I _{DS} =15A	-	7.2	9.4	
g_{fs}	Forward Transconductance	V _{DS} =5V, I _{DS} =5A	-	17.5	-	S
Dynamic Characteristics ^⑤						
R_G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, Freq.=1MHz	-	2.5	-	Ω
C_{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =20V, Freq.=1MHz	-	1990	-	pF
C_{oss}	Output Capacitance		-	214	-	
C_{rss}	Reverse Transfer Capacitance		-	151	-	
t_{d(ON)}	Turn-on Delay Time	V _{GS} =10V, V _{DS} =20V, I _D =1A, R _{GEN} =6Ω	-	10	-	nS
t_r	Turn-on Rise Time		-	22.4	-	
t_{d(OFF)}	Turn-off Delay Time		-	69.2	-	
t_f	Turn-off Fall Time		-	25	-	
Q_g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =35V, I _D =25A	-	27.5	-	nC
Q_g	Total Gate Charge	V _{GS} =10V, V _{DS} =35V, I _D =25A	-	52	-	
Q_{gs}	Gate-Source Charge		-	5.8	-	
Q_{gd}	Gate-Drain Charge		-	15	-	
Source-Drain Characteristics						
V_{SD} ^④	Diode Forward Voltage	I _{SD} =4A, V _{GS} =0V	-	0.7	1.1	V
t_{rr}	Reverse Recovery Time	I _F =4A, V _R =0V	-	19	-	nS
Q_{rr}	Reverse Recovery Charge	dI _F /dt=100A/μs	-	11	-	nC

Note ④ : Pulse test (pulse width≤300us, duty cycle≤2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

N-Channel Typical Characteristics

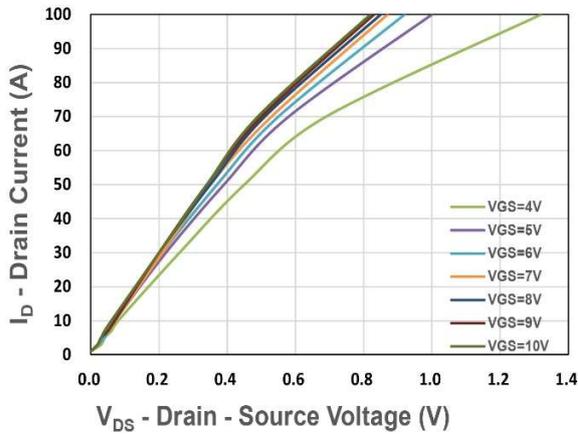


Figure 1. Output Characteristics

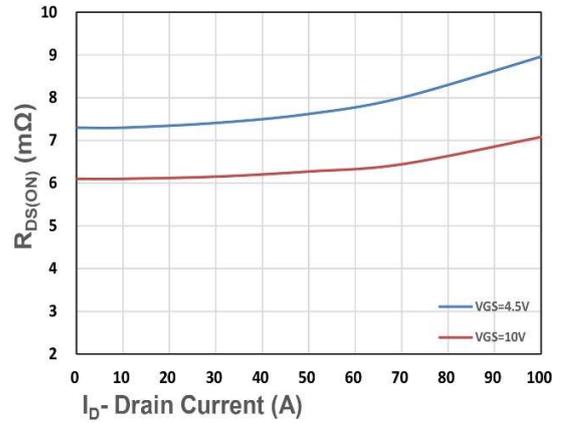


Figure 2. On-Resistance vs. ID

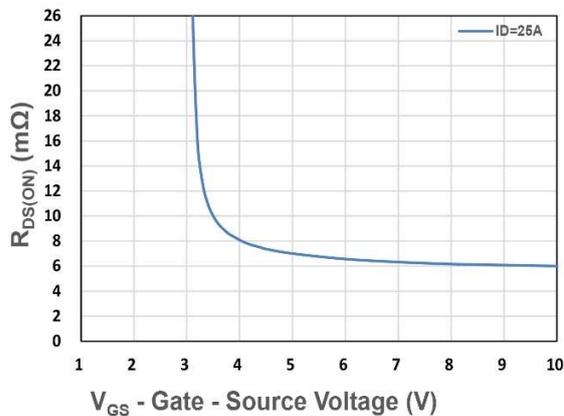


Figure 3. On-Resistance vs. VGS

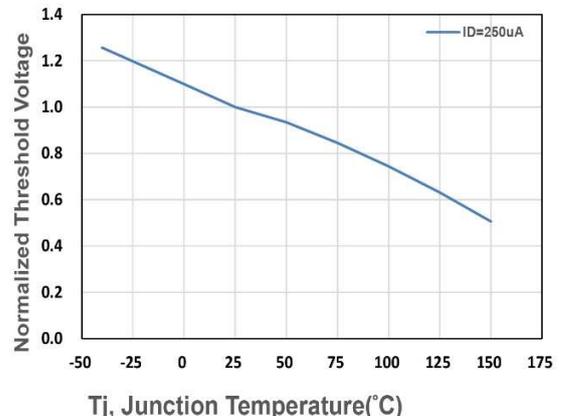


Figure 4. Gate Threshold Voltage

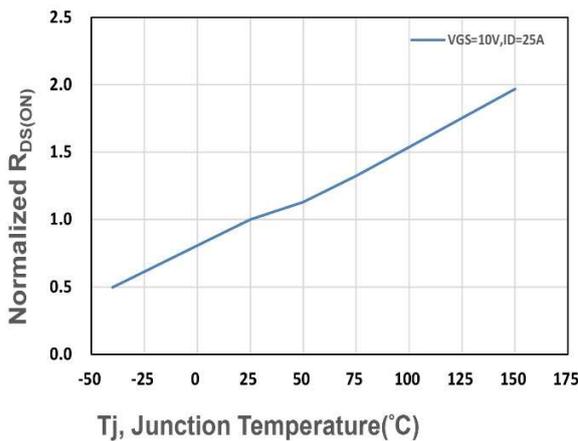


Figure 5. Drain-Source On Resistance

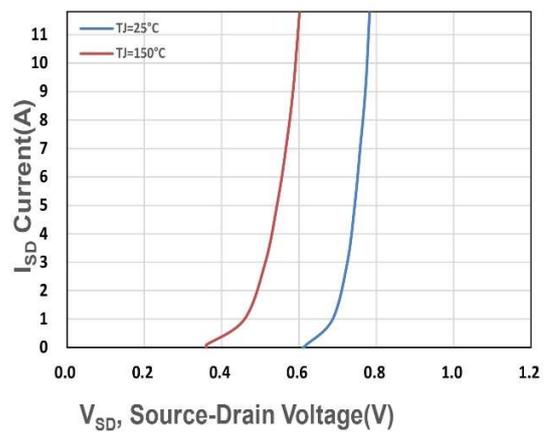


Figure 6. Source-Drain Diode Forward

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